

SPECIFICATION





Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CSM28R2CZ-1	InGaAIP	Red	Water Clear	25°	





ABSOLUTE MAXIMUM RATINGS

(TA=25°C

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	20	mA	
Reverse Current @ 5V	lr	10	μA	
Power Dissipation	Pd	60	mW	
Operating Temperature Range	Тор	-40~+85	°C	
Storage Temperature Range	Тѕтс	-40~+90	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	60	mA	
Soldering Temperature	Tsol	Max 260°C for 10 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Deremeter	Symbol	Test Candition	Value			Linit
Parameter		Test Condition	Min	Тур	Max	Unit
Luminous Intensity	١v	IF = 20mA	661	992	-	mcd
Forward Voltage	Vf	IF = 20mA	-	2.0	2.4	V
Reverse Leakage Current	lr	VR = 5V	-	-	10	μA
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	25	-	Deg
Peak Wavelength	λP	IF = 20mA	-	650	-	nm
Dominant Wavelength	λD	IF = 20mA	-	639	-	nm

*Tolerance of viewing angle: -10 / +5 deg.





OPTICAL CHARACTERISTIC CURVES



ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com

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PACKAGING SPECIFICATION







SOLDERING CONDITIONS

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big

current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 $^\circ\!{\rm C}$ or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 72 hours under 30° C or less and 60% RH or less.

If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the

storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



